# One source

for medical memory and storage solutions



### Micron memory supporting medical device manufacturers

The integration of technology in healthcare practices has made patient care more advanced, reliable, and patient-centric. Conventional techniques of diagnosis and the resulting therapies are becoming less invasive and more effective. Intelligent, connected portable devices are helping patients stay out of hospitals, allowing them to be monitored in the comfort of their own homes.

It is estimated that more than 8 billion new medical devices will be deployed over the next five years.<sup>1</sup> The best devices will be those that enable reliable patient care, protect patient data, require the least amount of maintenance, and enable healthcare providers to run hospitals and clinics efficiently.

Micron memory and storage solutions support medical device manufacturers who provide products such as consumer medical equipment, portable telehealth monitoring systems, clinical diagnostics, medical imaging, and medical robotics solutions.

Micron has been a trusted advisor to our industrial customers for more than 25 years. We understand the unique needs of this market and bring a mindset to deliver sustainable value to our customers—because we firmly believe that IQ matters to our customers' success in the medical devices market.

<sup>1</sup>Databeans, Inc. 2020 IND-Medical report

## What is Micron's industrial quotient (IQ)?

We bring to market a mindset and portfolio that delivers sustainable value to our customers with

#### **High reliability**

Design and testing processes that add a high level of endurance and reliability to align with needs of long-lifecycle embedded applications.

#### **Extensive quality testing**

Rigorous testing to deliver the consistent performance across products and processes necessary in embedded and mission-critical applications.

#### **Product longevity**

Extended lifecycle support for eligible products via our Product Longevity Program, which goes a step beyond standard lifecycle support to suit long-life applications.

#### Ruggedized products

Product enhancements that enable consistent performance across extreme environments: extended temperature, thermal cycling, shock, humidity, etc.

#### Application-specific tuning

Extensive collaboration with global customers to develop in-depth understanding of application use cases and deliver products and features to meet those specific application needs.



### Micron memory for industrial multimarket applications

Product family	Voltage	Bus width	Performance	Density range	Temp range <sup>2</sup>	Package options
DRAM components <sup>1</sup> and modules <sup>2</sup>						
DDR5 SDRAM (MT6O)	1.1V <sup>1</sup>	x8, x16¹	4800-7200 MT/s <sup>1</sup>	16-24Gb <sup>1</sup> ; 8-128GB <sup>2</sup>	IT, AT, CT <sup>1</sup> , CT <sup>2</sup>	BGA, FBGA <sup>1</sup> ; ECC/SODIMM ECC/UDIMM, RDIMM <sup>2</sup>
DDR4 SDRAM (MT4O)	1.2V <sup>1</sup>	x8, x16¹	2133-3200 MT/s1	8-32Gb <sup>1</sup> ; 4-64GB <sup>2</sup>	IT, AT, CT <sup>1</sup> , CT <sup>2</sup>	BGA, FBGA <sup>1</sup> ; ECC/SODIMM ECC/UDIMM, RDIMM <sup>2</sup>
DDR3 SDRAM (MT41)	1.35V <sup>1</sup>	x8, x16¹	1600-2133 MT/s <sup>1</sup>	1-8Gb <sup>1</sup> ; 2-8GB <sup>2</sup>	IT, AT, UT, CT <sup>2</sup>	BGA, FBGA <sup>1</sup> ; ECC/SODIMN ECC/UDIMM, RDIMM <sup>2</sup>
DDR2 SDRAM (MT47)	1.8V <sup>1</sup>	x8, x16¹	800 MT/s1	512Mb-2Gb1	IT, AT <sup>1</sup> , CT <sup>2</sup>	BGA, VFBGA <sup>1</sup>
SDRAM (MT48)	3.3V1	x8, x16¹	266-333 MT/s1	64Mb-256Mb1	IT <sup>1</sup> , CT <sup>2</sup>	TSOP, VFBGA <sup>1</sup>
Low Power DRAM						
LPDDR5 (MT62)	1.05V, 1.8V	x16, x32, x64	Up to 8.5 Gbps	16-128Gb	wt, it, ai, At, ut	BGA, PoP
LPDDR4 (MT53)	1.1V	x16, x32, x64	Up to 4.2 Gbps	4-128Gb	WT, IT, AT	BGA, PoP
LPDDR3	1.2V	x32, x64	Up to 2.3 Gbps	8-32Gb	WT	BGA, PoP
LPDDR2	1.2V	x32	533 MHz	512Mb-2Gb	IT, AT	BGA
SLC NAND						
Serial SLC NAND LP/VLP	1.8V, 3V	x1, x2, x4	Up to 133 MHz, on-die (zero) ECC	1-32Gb SPI NAND SLC	IT, AT, CT	DFN, BGA, wafer
Parallel SLC NAND LP/VLP	1.8V, 3V	x8, x16	8-bit or on-die (zero) ECC	1-256Gb P-NAND SLC	IT, AT, CT	TSOP, BGA, wafer
NOR flash						
Octal NOR (MT35X)	1.8V, 3V	x1, x8	200 MHz DDR	256Mb-2Gb	IT, AT, UT	BGA
Serial NOR (MT25Q)	1.8V, 3V	x1, x2, x4	133-166 MHz	128Mb-2Gb	IT, AT, UT	BGA, CSP, DFN, KGD, SOIC
Parallel NOR (MT28EW)	3V	x8, x16	Async	128Mb-2Gb	IT, AT	TSOP, BGA
eMCPs and MCPs						
e.MMC + LPDDR4 eMCP	3.3V	x8 e.MMC, x32 LPDDR4	v5.1 (e.MMC); 2133 MHz (LPDDR4)	32GB e.MMC + 16Gb LPDDR4	IT	BGA
NAND + LPDDR4 MCP	1.8V	x8 NAND, x16, x32 LPDDR4	100K P/E SLC NAND; 1866-2133 MHz (LPDDR4)	4-16Gb SLC NAND + 4-16Gb LPDDR4	IT	BGA
NAND + LPDDR2 MCP	1.8V	x8 NAND, x32 LPDDR2	100K P/E SLC NAND; 533 MHz (LPDDR2)	4Gb SLC NAND + 2-4Gb LPDDR2	IT	BGA
Storage						
SSD (2100 AI)	3.3V/1.2V/ 0.9V	x4	PCle Gen3	64GB-1TB	AI	BGA, M.2 (Type 2230)
Memory cards	3.3V	x4	SD3.0 UHS-I, U1/U3, Class 10	32GB-1.5TB	WT	microSD
e.MMC	3V	x1, x4, x8	e.MMC v5.0, e.MMC v5.1	32GB-256GB	WT, IT	BGA
UFS	1.2/3.3V	x1, x2	JESD22OC 2.1, JESD22OD 3.1	32GB-256GB	IT, AT	TFBGA, LFBGA

1. This table contains design-in products only.

2. Typical temperature range: IT = -40°C to 85°C; AI = -40°C to 95°C; WT = -25°C to 85°C; AT = -40°C to 105°C; UT = -40°C to 125°C

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